BPX 61

Metal Can® TO39

Silicon PIN Photodiode





Applications

 Industrial Automation (Machine Controls, Light Barriers, Vision Controls)

Features:

- Package: hermetically sealed
- ESD: 2 kV acc. to ANSI/ESDA/JEDEC JS-001 (HBM, Class 2)
- Suitable up to 125 °C
- Especially suitable for applications from 400 nm to 1100 nm
- Short switching time (typ. 20 ns)
- Hermetically sealed metal package (similar to TO-5)

Ordering Information

Type	Photocurrent	Photocurrent	Ordering Code
		typ.	
	$E_v = 1000 \text{ lx}$; Std. Light A; $V_R = 5 \text{ V}$	$E_v = 1000 \text{ lx}$; Std. Light A; $V_R = 5 \text{ V}$	
	I _P	I _P	
BPX 61	≥ 50 µA	70 μΑ	Q62705P0025



Maximum Ratings

T_A = 25 °C

Parameter	Symbol		Values
Operating Temperature	T _{op}	min. max.	-40 °C 125 °C
Storage temperature	T_{stg}	min. max.	-40 °C 125 °C
Reverse voltage	V_R	max.	32 V
Total power dissipation	P _{tot}	max.	250 mW
ESD withstand voltage acc. to ANSI/ESDA/JEDEC JS-001 (HBM, Class 2)	V_{ESD}	max.	2 kV



Characteristics

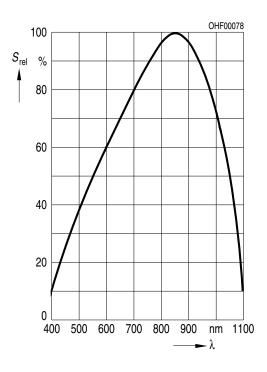
Τ.	=	25	$^{\circ}C$
- A			_

Parameter	Symbol		Values
Spectral sensitivity $V_R = 5 \text{ V}$	S	min. typ.	50 nA/lx 70 nA/lx
Wavelength of max sensitivity	$\lambda_{_{ m S\ max}}$	typ.	850 nm
Spectral range of sensitivity	λ _{10%}	typ.	400 1100 nm
Radiant sensitive area	А	typ.	7.02 mm²
Dimensions of active chip area	L×W	typ.	2.65 x 2.65 mm x mm
Half angle	φ	typ.	55 °
Dark current $V_R = 10 \text{ V}$	I _R	typ. max.	2 nA 30 nA
Spectral sensitivity of the chip $\lambda = 850 \text{ nm}$	$S_{_{\lambda}}$	typ.	0.62 A / W
Quantum yield of the chip $\lambda = 850 \text{ nm}$	η	typ.	0.90 Electrons / Photon
Open-circuit voltage E _v = 1000 lx; Std. Light A	V _o	min. typ.	320 mV 375 mV
Short-circuit current E _v = 1000 lx; Std. Light A	I _{sc}	typ.	70 μΑ
Rise time $V_R = 5 \text{ V}; R_L = 50 \Omega; \lambda = 850 \text{ nm}; I_P = 800 \mu\text{A}$	t _r	typ.	0.02 μs
Fall time $V_R = 5 \text{ V}; R_L = 50 \Omega; \lambda = 850 \text{ nm}; I_P = 800 \mu\text{A}$	t _f	typ.	0.02 μs
Forward voltage I _F = 100 mA; E = 0	V_{F}	typ.	1.3 V
Capacitance $V_R = 0 \text{ V}; f = 1 \text{ MHz}; E = 0$	C _o	typ.	72 pF
Temperature coefficient of voltage	TC _v	typ.	-2.6 mV / K
Temperature coefficient of short-circuit current Std. Light A	TC _I	typ.	0.18 % / K
Noise equivalent power $V_R = 10 \text{ V}; \lambda = 850 \text{ nm}$	NEP	typ.	0.041 pW / Hz ^{1/2}
Detection limit	D*	typ.	6.5e12 cm x Hz ^{1/2} / W



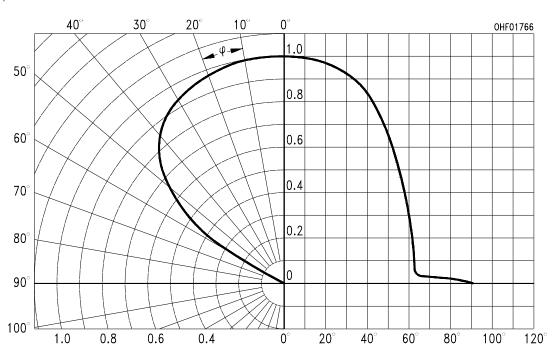
Relative Spectral Sensitivity 1), 2)

 $S_{rel} = f(\lambda)$



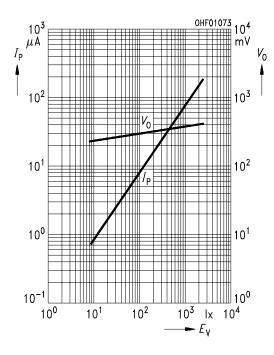
Directional Characteristics 1), 2)

 $S_{rel} = f(\phi)$



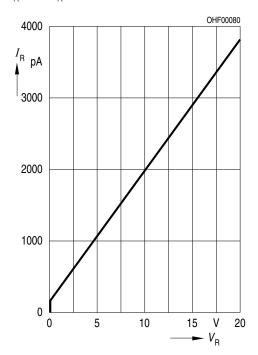
Photocurrent/Open-Circuit Voltage 1), 2)

$$I_P (V_R = 5 \text{ V}) / V_O = f (E_v)$$



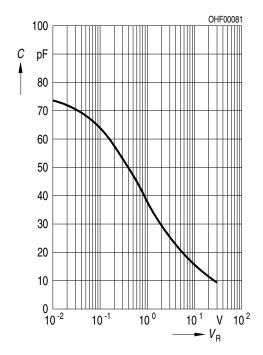
Dark Current 1), 2)

$$I_R = f(V_R); E = 0$$



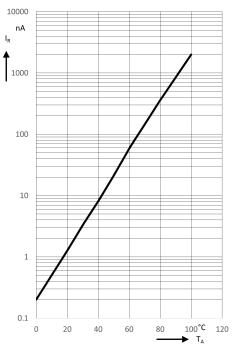
Capacitance 1), 2)

$$C = f(V_R); f = 1 MHz; E = 0;$$



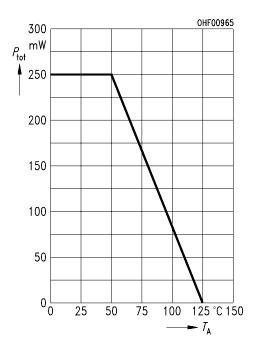
Dark Current 1)

$$I_{R} = f(T_{A}); E = 0; V_{R} = 10 V$$



Power Consumption

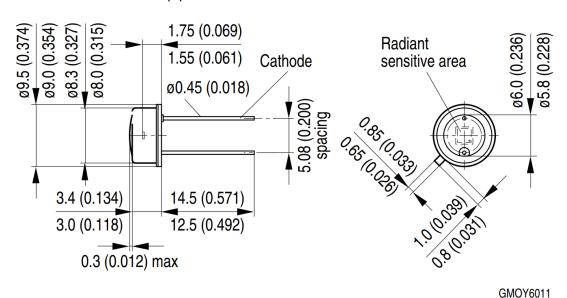
$$P_{tot} = f(T_A)$$





Dimensional Drawing 3)

Chip position



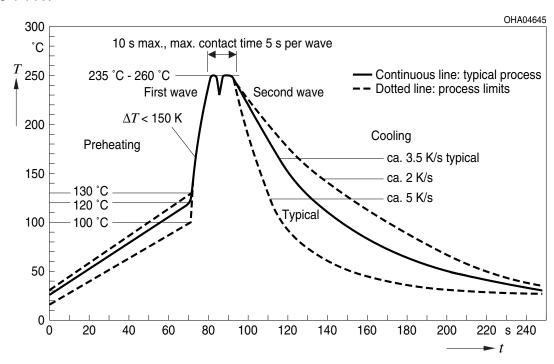
CIVIO 10011

Approximate Weight: 855.0 mg

Package marking: Cathode

TTW Soldering

IEC-61760-1 TTW





Notes

The evaluation of eye safety occurs according to the standard IEC 62471:2006 (photo biological safety of lamps and lamp systems). Within the risk grouping system of this IEC standard, the device specified in this data sheet falls into the class **exempt group (exposure time 10000 s)**. Under real circumstances (for exposure time, conditions of the eye pupils, observation distance), it is assumed that no endangerment to the eye exists from these devices. As a matter of principle, however, it should be mentioned that intense light sources have a high secondary exposure potential due to their blinding effect. When looking at bright light sources (e.g. headlights), temporary reduction in visual acuity and afterimages can occur, leading to irritation, annoyance, visual impairment, and even accidents, depending on the situation.

Subcomponents of this device contain, in addition to other substances, metal filled materials including silver. Metal filled materials can be affected by environments that contain traces of aggressive substances. Therefore, we recommend that customers minimize device exposure to aggressive substances during storage, production, and use. Devices that showed visible discoloration when tested using the described tests above did show no performance deviations within failure limits during the stated test duration. Respective failure limits are described in the IEC60810.

For further application related informations please visit www.osram-os.com/appnotes



Disclaimer

Attention please!

The information describes the type of component and shall not be considered as assured characteristics. Terms of delivery and rights to change design reserved. Due to technical requirements components may contain dangerous substances.

For information on the types in question please contact our Sales Organization.

If printed or downloaded, please find the latest version on the OSRAM OS webside.

Packing

Please use the recycling operators known to you. We can also help you – get in touch with your nearest sales office.

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Glossary

- Typical Values: Due to the special conditions of the manufacturing processes of semiconductor devices, the typical data or calculated correlations of technical parameters can only reflect statistical figures. These do not necessarily correspond to the actual parameters of each single product, which could differ from the typical data and calculated correlations or the typical characteristic line. If requested, e.g. because of technical improvements, these typ. data will be changed without any further notice.
- 2) Testing temperature: TA = 25°C
- Tolerance of Measure: Unless otherwise noted in drawing, tolerances are specified with ±0.1 and dimensions are specified in mm.



Revision History

Version	Date	Change
1.4	2019-01-08	Package Outline



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